LNJ426W83RA1

Surface Mounting Chip LED

UTSS Type

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	40	mW	
Forward current	I _F	15	mA	
Pulse forward current *	I _{FP}	40	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-30 to +85	°C	
Storage temperature	T _{stg}	-40 to +100	°C	

Lighting Color

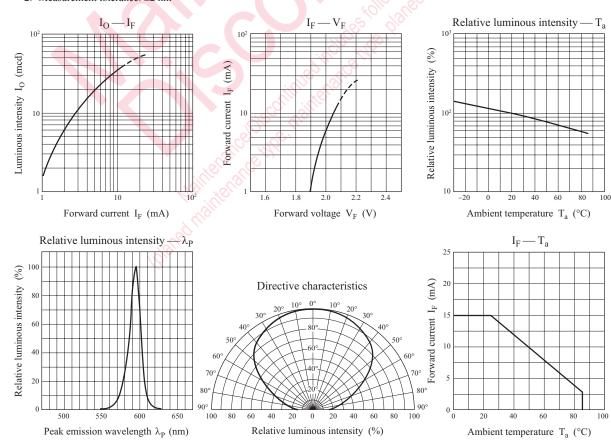
• Amber

Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

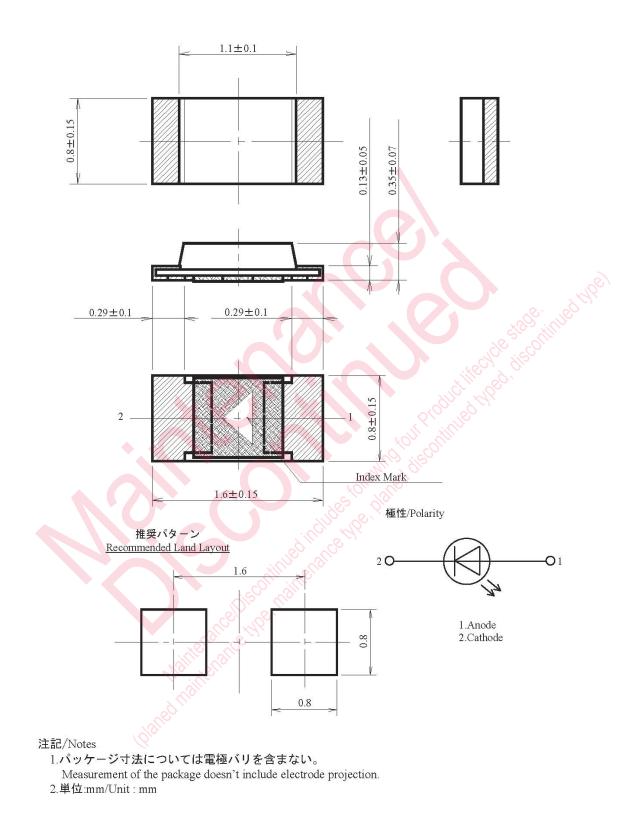
1 4						$\chi \sim$
Parameter	Symbol	Conditions	Min	Тур	Max	💛 Unit
Luminous intensity *1	I _O	$I_{\rm F} = 10 \ {\rm mA}$	12.0	35.0	102.0	mcd
Reverse current	I _R	$V_R = 4 V$		5 6	100	μΑ
Forward voltage	V _F	$I_F = 10 \text{ mA}$		2.05	2.5	V
Peak emission wavelength	$\lambda_{\rm P}$	$I_F = 10 \text{ mA}$	0000	595		nm
Dominant emission wavelength *2	λ_d	$I_F = 10 \text{ mA}$	585	589	596	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	OUN	15		nm

Note) *1: Measurement tolerance: ±20% *2: Measurement tolerance: ±2 nm



Publication date: December 2016

Package (Unit: mm)



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